



Material Composition Sheet

Product: GS9007ACTA-L
 Package Type: SOIC-8 taped (1000/reel)
 Manufacturer: Gennum Corporation

Date: 12-Dec-2006

Component	BOM	Weight of Component (mg)	Substance	Weight of Substance (mg)	Homogeneous Material	
					%	ppm
Chip		1.53	Al	0.01	0.65	6536
			Si	1.52	99.34	993464
			Sub-total:	1.53	99.99	1000000
Die Attach	84-1 LMISR4	0.14	Aromatic Amine	0.01	7.14	71429
			Epoxy Resin	0.02	14.28	142857
			Silver	0.11	78.57	785714
			Sub-total:	0.14	99.99	1000000
Lead Finish External		1.41	Pb	0.35	24.82	248227
			Sn	1.06	75.17	751773
			Sub-total:	1.41	99.99	1000000
Lead Finish Internal		0.19	Ag	0.19	100.00	1000000
			Sub-total:	0.19	100.00	1000000
Leadframe	Olin 194FH	24.26	Cu	23.65	97.48	974856
			Fe	0.57	2.34	23495
			P	0.01	0.04	412
			Zn	0.03	0.12	1237
			Sub-total:	24.26	99.98	1000000
Marking Ink	Wieder W238	0.00		0.00	0.00	0
			Sub-total:	0.00	0.00	0
Mold Compound	EME 6300H	46.18	Antimony Trioxide	1.39	3.00	30100
			BrominatedEpoxyResin	0.91	1.97	19706
			Carbon Black	0.14	0.30	3032
			Epoxy Cresol Novolac	7.39	16.00	160026
			Phenol/Novolac resin	2.63	5.69	56951
			Silica Fused	33.72	73.01	730186
			Sub-total:	46.18	99.97	1000001
Wires	SGA3	0.21	Au	0.21	100.00	1000000
			Sub-total:	0.21	100.00	1000000
Total:		73.92				

GENNUM CORPORATION

Mailing Address: P.O. Box 489, Stn. A, Burlington, Ontario, Canada L7R 3Y3
 Shipping Address: 970 Fraser Drive, Burlington, Ontario, Canada L7L 5P5
 Tel. +1 (905) 632-2996 Fax. +1 (905) 632-5946

www.gennum.com

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